

DATA SHEET

74F299

8-bit universal shift/storage register
(3-State)

Product specification

1990 Mar 01

IC15 Data Handbook

8-bit universal shift/storage register (3-State)

74F299

FEATURES

- Common parallel I/O for reduced pin count
- Additional serial inputs and outputs for expansion
- Four operating modes: Shift left, shift right, load and store
- 3-State outputs for bus-oriented applications

DESCRIPTION

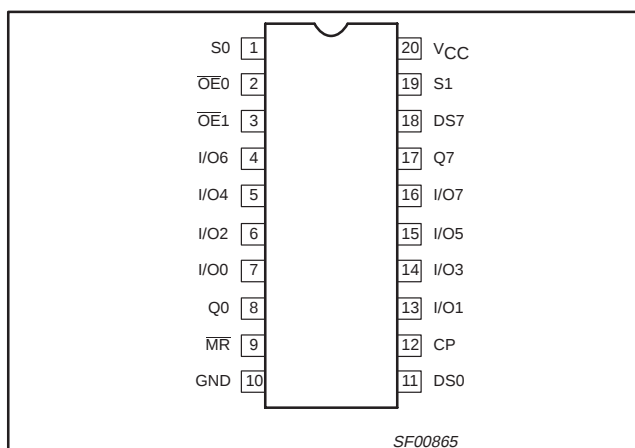
The 74F299 is an 8-bit universal shift/storage register with 3-State outputs. Four modes of operation are possible: Hold (store), shift left, shift right and parallel load. The parallel load inputs and flip-flop outputs are multiplexed to reduce the total number of package pins. Additional outputs are provided for flip-flops Q0 and Q7 to allow easy serial cascading. A separate active-Low Master Reset is used to reset the register.

The 74F299 contains eight edge-triggered D-type flip-flops and the interstage logic necessary to perform synchronous shift left, shift right, parallel load and hold operations. The type of operation is determined by S0 and S1, as shown in the Function Table. All flip-flop outputs are brought out through 3-State buffers to separate I/O pins that also serve as data inputs in the parallel load mode. Q0 and Q7 are also brought out on other pins for expansion in serial shifting of longer words.

A Low signal on $\overline{MR}$ overrides the Select and CP inputs and resets the flip-flops. All other state changes are initiated by the rising edge of the clock. Inputs can change when the clock is in either state provided only that the recommended setup and hold times, relative to the rising edge of clock are observed.

A High signal on either $\overline{OE}0$ or $\overline{OE}1$ disables the 3-State buffers and puts the I/O pins in the high impedance state. In this condition the shift, hold, load and reset operations can still occur. The 3-State buffers are also disabled by High signals on both S0 and S1 in preparation for a parallel load operation.

PIN CONFIGURATION



TYPE	TYPICAL f_{MAX}	TYPICAL SUPPLY CURRENT (TOTAL)
74F299	115MHz	58mA

ORDERING INFORMATION

DESCRIPTION	ORDER CODE	PKG DWG #
	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$, $T_{amb} = 0^{\circ}C \text{ to } +70^{\circ}C$	
20-pin plastic DIP	N74F299N	SOT146-1
20-pin plastic SOL	N74F299D	SOT163-1
20-pin plastic SSOP II	N74F299DB	SOT339-1

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

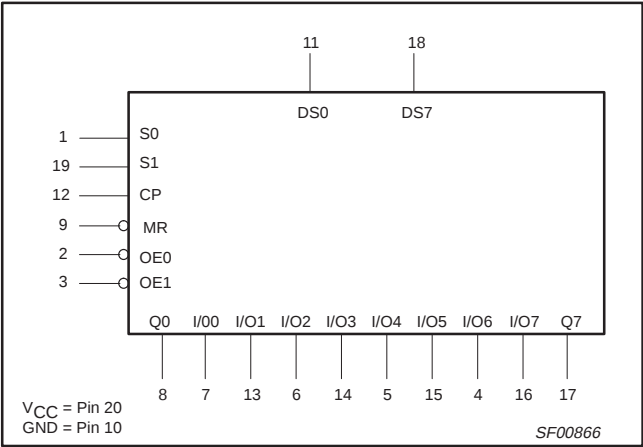
PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
DS0	Serial data input for right shift	1.0/1.0	20 μ A/0.6mA
DS7	Serial data input for left shift	1.0/1.0	20 μ A/0.6mA
S0, S1	Mode select inputs	1.0/2.0	20 μ A/1.2mA
CP	Clock pulse input (Active rising edge)	1.0/1.0	20 μ A/0.6mA
$\overline{MR}$	Asynchronous Master Reset input (Active Low)	1.0/1.0	20 μ A/0.6mA
$\overline{OE}0, \overline{OE}1$	Output Enable input (Active Low)	1.0/1.0	20 μ A/0.6mA
Q0, Q7	Serial outputs	50/33	1.0mA/20mA
I/On	Multiplexed parallel data inputs or	3.5/1.0	70 μ A/0.6mA
	3-State parallel outputs	150/40	3.0mA/24mA

NOTE: One (1.0) FAST Unit Load (U.L.) is defined as: 20 μ A in the High State and 0.6mA in the Low state.

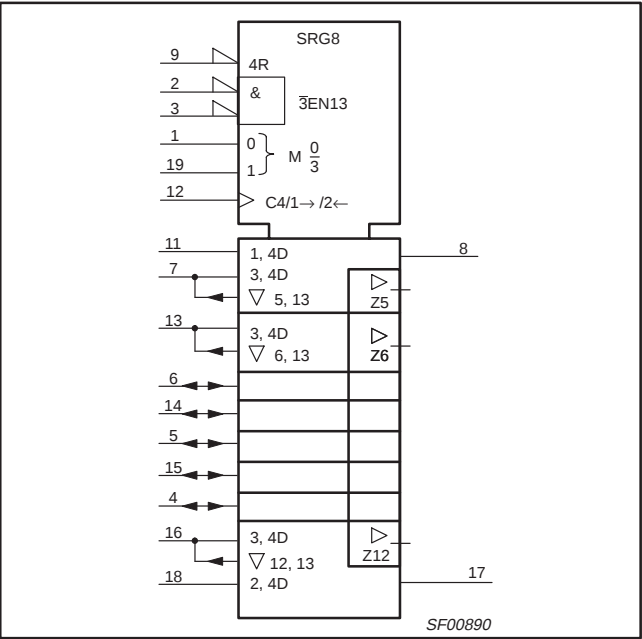
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LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLE

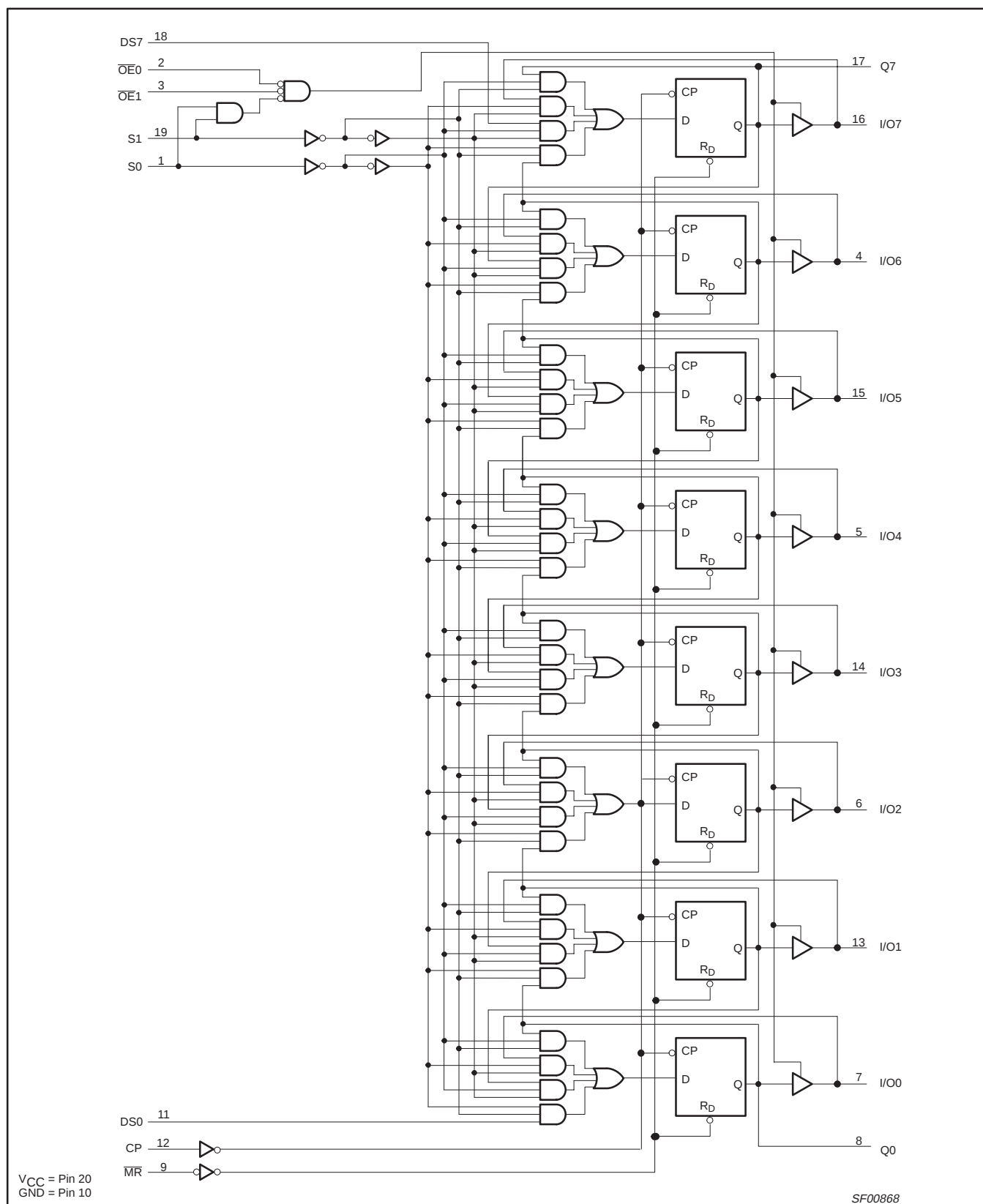
INPUTS		INPUTS			OPERATING MODE
OE _{En}	MR	S1	S0	CP	
L	L	X	X	X	Asynchronous Reset; Q0 - Q7 = Low
L	H	H	H	↑	Parallel load; I/On → Qn (I/On outputs disabled)
L	H	L	H	↑	Shift right; DS0 → Q0, Q0 → Q1, etc.
L	H	H	L	↑	Shift left; DS7 → Q7, Q7 → Q6, etc.
L	H	L	L	X	Hold
H	X	X	X	X	Outputs in High Z

H = High voltage level
L = Low voltage level
X = Don't care
↑ = Low-to-High clock transition

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LOGIC DIAGRAM



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ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V_{CC}	Supply voltage		-0.5 to +7.0	V
V_{IN}	Input voltage		-0.5 to +7.0	V
I_{IN}	Input current		-30 to +5	mA
V_{OUT}	Voltage applied to output in High output state		-0.5 to + V_{CC}	V
I_{OUT}	Current applied to output in Low output state	Q0, Q7	40	mA
		I/On	48	mA
T_{amb}	Operating free-air temperature range		0 to +70	°C
T_{stg}	Storage temperature		-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		LIMITS			UNIT
			MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5.0	5.5	V
V_{IH}	High-level input voltage		2.0			V
V_{IL}	Low-level input voltage				0.8	V
I_{IK}	Input clamp current				-18	mA
I_{OH}	High-level output current	Q0, Q7			-1	mA
		I/On			-3	mA
I_{OL}	Low-level output current	Q0, Q7			20	mA
		I/On			24	mA
T_{amb}	Operating free-air temperature range		0		70	°C

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DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIONS ^{NO TAG}			LIMITS			UNIT
						MIN	TYP NO TAG	MAX	
V _{OH}	High-level output voltage	Q0, Q7	V _{CC} = MIN, V _{IL} = MAX, V _{IH} = MIN	I _{OH} = −1mA	±10%V _{CC}	2.5			V
					±5%V _{CC}	2.7	3.4		V
		I/On		I _{OH} = −3mA	±10%V _{CC}	2.4			V
					±5%V _{CC}	2.7	3.3		V
V _{OL}	Low-level output voltage		V _{CC} = MIN, V _{IL} = MAX, V _{IH} = MIN	I _{OL} = MAX	±10%V _{CC}		0.35	0.50	V
					±5%V _{CC}		0.35	0.50	V
V _{IK}	Input clamp voltage		V _{CC} = MIN, I _I = I _{IK}				−0.73	−1.2	V
I _I	Input current at maximum input voltage	others	V _{CC} = MAX, V _I = 7.0V					100	μA
		I/On	V _{CC} = 5.5V, V _I = 5.5V					1	mA
I _{IH}	High-level input current	except I/On	V _{CC} = MAX, V _I = 2.7V					20	μA
I _{IL}	Low-level input current	S0, S1	V _{CC} = MAX, V _I = 0.5V					−1.2	mA
		others						−0.6	mA
I _{IH} + I _{OZH}	Off-state output current, High-level voltage applied	I/On only	V _{CC} = MAX, V _O = 2.7V					70	μA
I _{IL} + I _{OZL}	Off-state output current Low-level voltage applied		V _{CC} = MAX, V _O = 0.5V					−0.6	mA
I _{OS}	Short-circuit output current ^{NO TAG}		V _{CC} = MAX			−60		−150	mA
I _{CC}	Supply current (total)	I _{CCH}	V _{CC} = MAX				55	60	mA
		I _{CCL}					70	90	mA
		I _{CCZ}					65	95	mA

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at $V_{CC} = 5\text{V}$, $T_{\text{amb}} = 25^\circ\text{C}$.
- Not more than one output should be shorted at a time. For testing I_{OS} , the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

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AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER		TEST CONDITIONS	LIMITS					UNIT
				T _{amb} = +25°C V _{CC} = +5.0V C _L = 50pF, R _L = 500Ω			T _{amb} = 0°C to +70°C V _{CC} = +5.0V ± 10% C _L = 50pF, R _L = 500Ω		
				MIN	TYP	MAX	MIN	MAX	
f _{MAX}	Maximum clock frequency	I/O	Waveform 1	70	100		70		MHz
		Qn		85	115		85		MHz
t _{PLH} t _{PHL}	Propagation delay CP to Q0 or Q7		Waveform 1	4.0 4.5	5.0 6.0	7.5 8.0	3.5 4.5	8.5 8.5	ns ns
t _{PLH} t _{PHL}	Propagation delay CP to I/On		Waveform 1	4.0 4.0	6.0 6.5	9.0 9.0	4.0 4.0	10.0 10.0	ns ns
t _{PHL}	Propagation delay MR to Q0 or Q7		Waveform 2	5.5	7.5	9.5	5.5	10.5	ns
t _{PHL}	Propagation delay MR to I/On		Waveform 2	5.5	7.5	10.0	5.5	10.5	ns
t _{PZH} t _{PZL}	Output Enable time Sn, OE to I/On		Waveform 4 Waveform 5	3.5 4.0	6.0 7.5	8.0 10.0	3.5 4.0	9.0 11.0	ns ns
t _{PHZ} t _{PLZ}	Output Disable time Sn, OE to I/On		Waveform 4 Waveform 5	2.5 1.5	4.5 2.5	7.0 5.5	2.5 1.5	8.0 6.5	ns ns

AC SETUP REQUIREMENTS

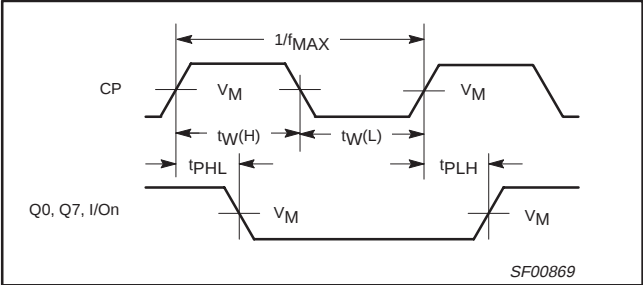
SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			T _{amb} = +25°C V _{CC} = +5.0V C _L = 50pF, R _L = 500Ω			T _{amb} = 0°C to +70°C V _{CC} = +5.0V ± 10% C _L = 50pF, R _L = 500Ω		
			MIN	TYP	MAX	MIN	MAX	
t _S (H) t _S (L)	Setup time, High or Low S0 or S1 to CP	Waveform 3	6.5 6.5			7.5 7.5		ns ns
t _h (H) t _h (L)	Hold time, High or Low S0 or S1 to CP	Waveform 3	0 0			0 0		ns ns
t _S (H) t _S (L)	Set-up time, High or Low I/On, DS _L or DS _R to CP	Waveform 3	3.5 3.5			4.0 4.0		ns ns
t _h (H) t _h (L)	Hold time, High or Low I/On, DS _L or DS _R to CP	Waveform 3	0 0			0 0		ns ns
t _w (H) t _w (L)	CP Pulse width, High or Low	Waveform 1	5.0 4.5			5.0 4.5		ns
t _w (L)	$\overline{\text{MR}}$ Pulse width, Low	Waveform 2	4.5			4.5		ns
t _{rec}	Recovery time, $\overline{\text{MR}}$ to CP	Waveform 2	4.0			4.0		ns

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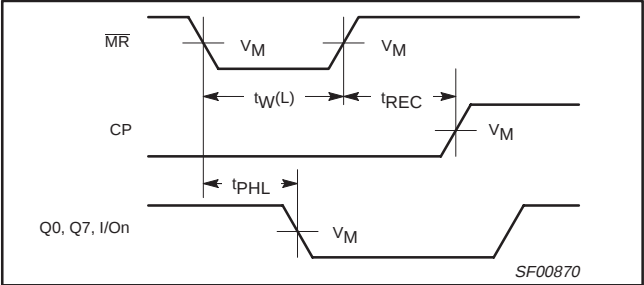
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AC WAVEFORMS

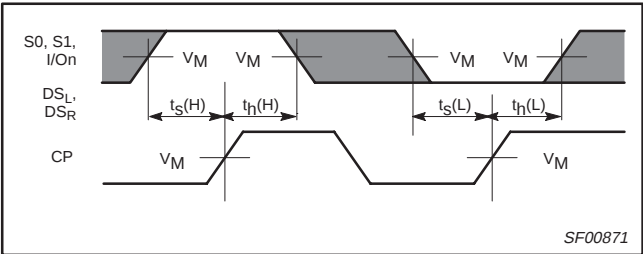
For all waveforms, $V_M = 1.5V$
The shaded areas indicate when the input is permitted to change for predictable output performance.



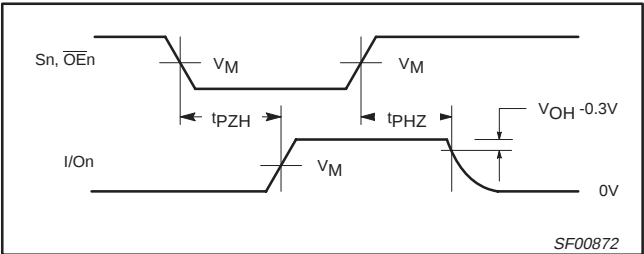
Waveform 1. Propagation Delay, Clock Input to Output, Clock Width, and Maximum Clock Frequency



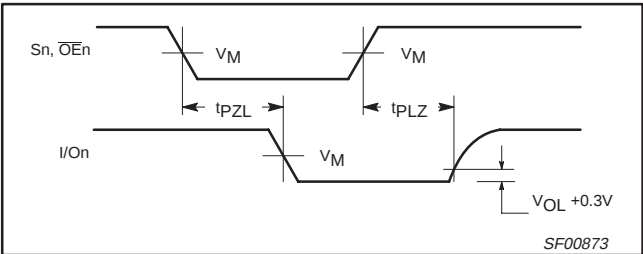
Waveform 2. Master Reset Pulse Width, Master Reset to Output Delay, and Master Reset to Clock Recovery Time



Waveform 3. Setup and Hold Times



Waveform 4. 3-State Output Enable Time to High Level and Output Disable Time from High Level

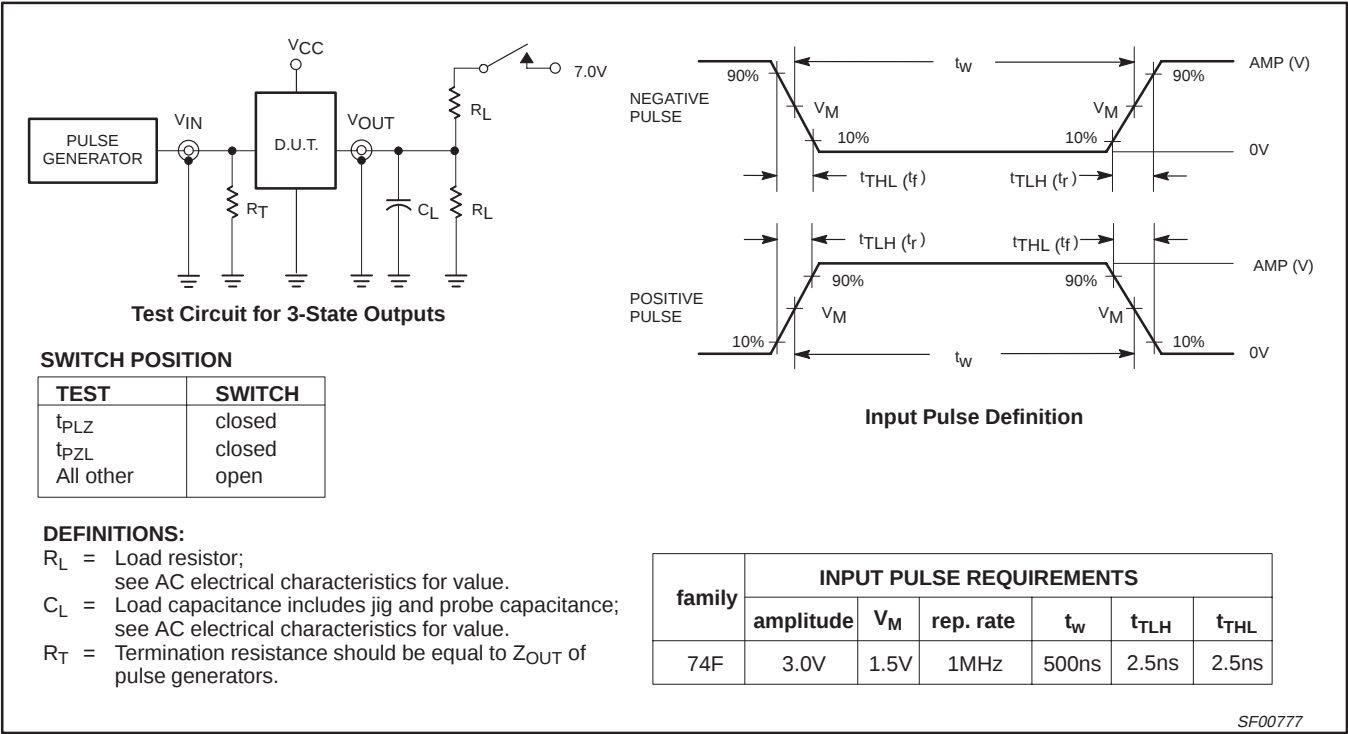


Waveform 5. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

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TEST CIRCUIT AND WAVEFORM

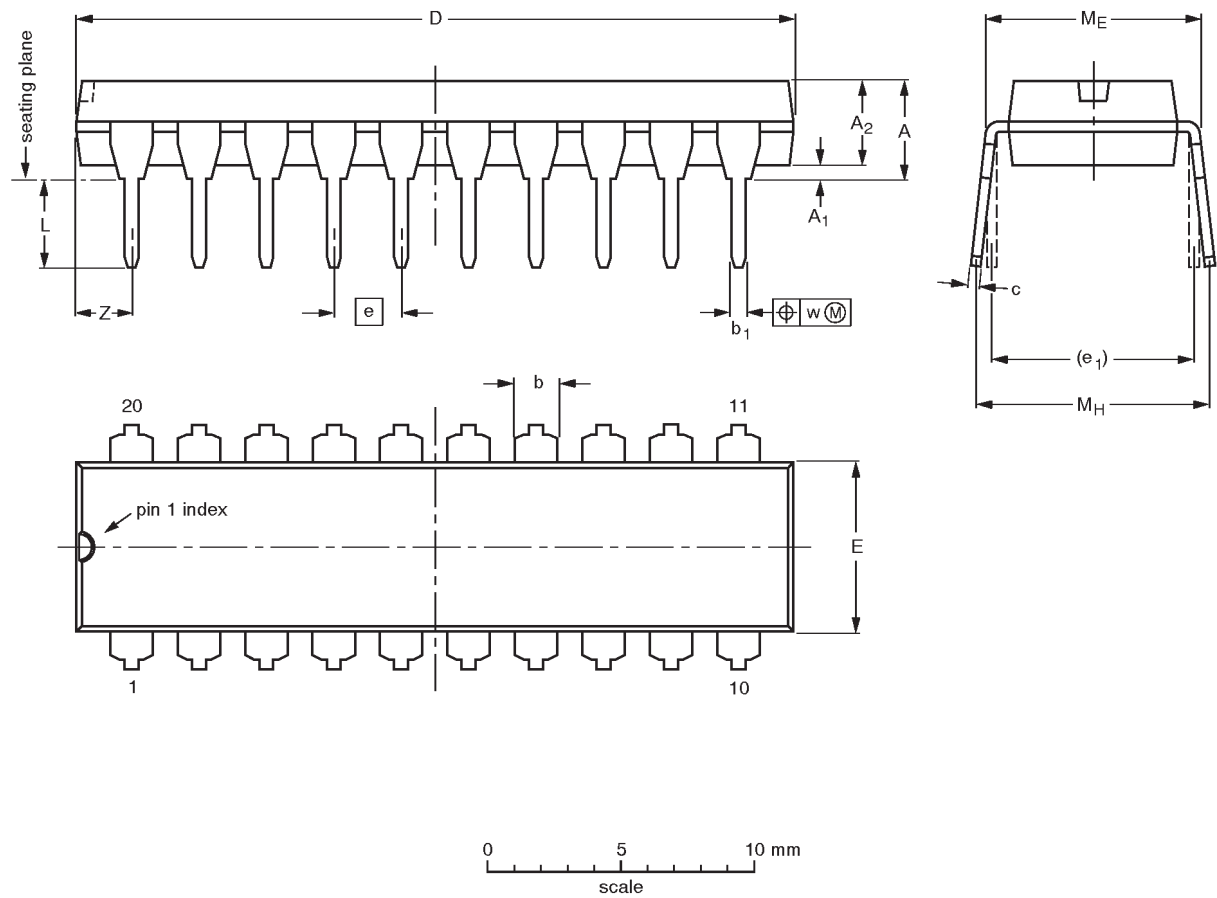


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DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

Note
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

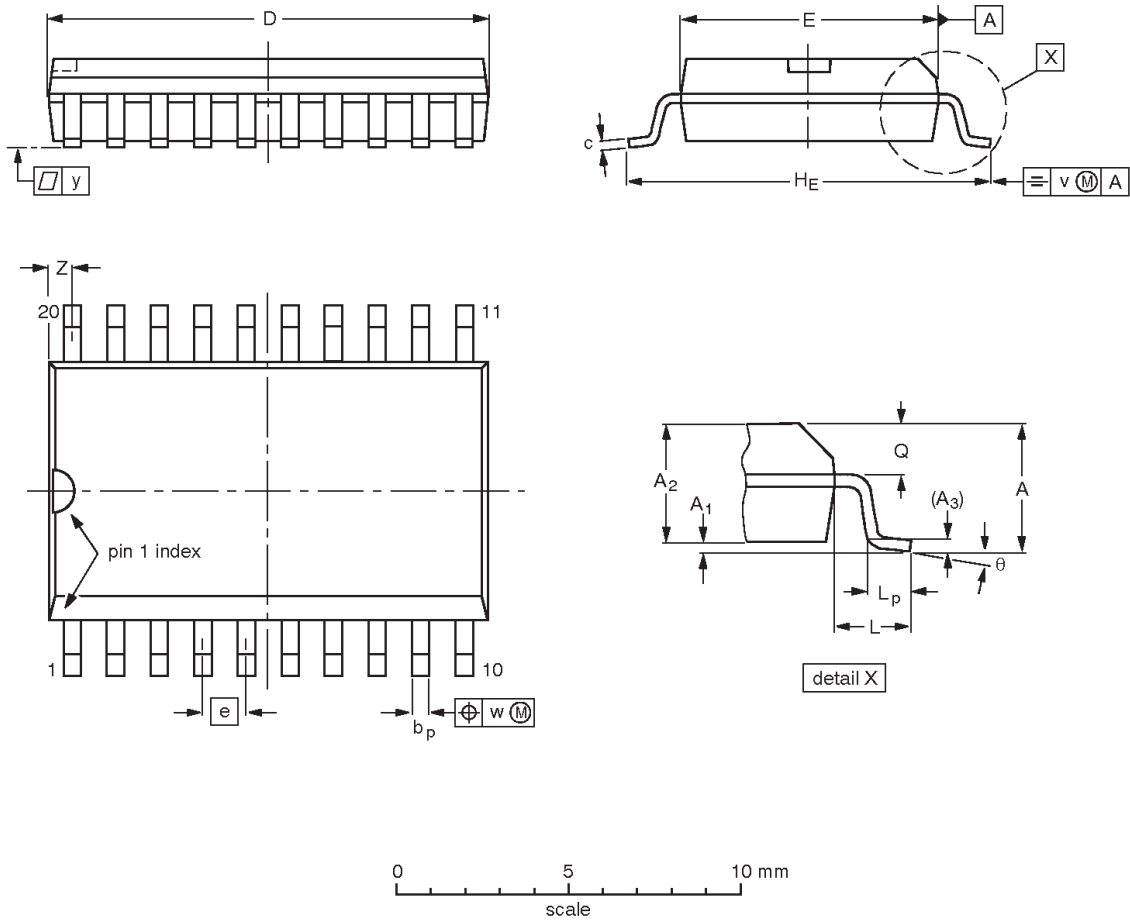
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT146-1			SC603			92-11-17 95-05-24

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SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

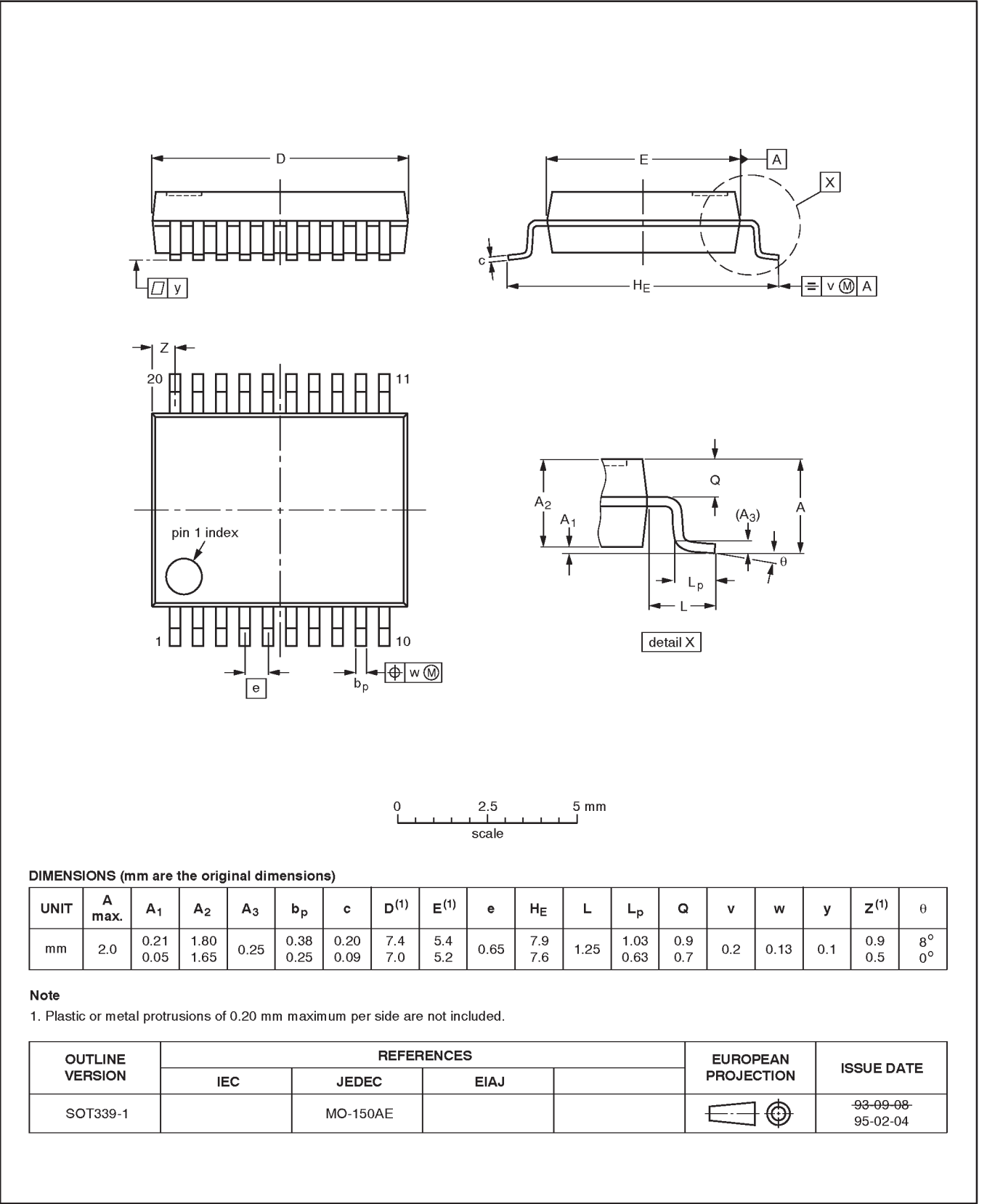
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT163-1	075E04	MS-013AC				-95-01-24 97-05-22

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

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NOTES

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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